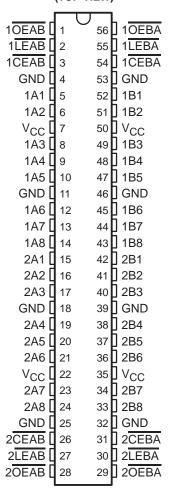
- **Members of the Texas Instruments** Widebus™ Family
- Inputs Are TTL-Voltage Compatible
- **3-State True Outputs**
- Flow-Through Architecture Optimizes PCB Layout
- Distributed V_{CC} and GND Pin **Configurations Minimize High-Speed Switching Noise**
- **EPIC** [™] (Enhanced-Performance Implanted CMOS) 1-um Process
- 500-mA Typical Latch-Up Immunity at
- **Package Options Include Plastic Thin** Shrink Small-Outline (DGG) and 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings, and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center **Pin Spacings**

description

The 'ACT16543 are 16-bit registered transceivers that contain two sets of D-type latches for temporary storage of data flowing in either direction. The 'ACT16543 can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch enable (LEAB or LEBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (CEAB) and OEAB inputs must be low to enter data from A or to output data to B. Having CEAB low and LEAB low makes the A-to-B latches transparent; a subsequent low-tohigh transition at LEAB puts the A latches in the storage mode. Data flow from B to A is similar, but requires using the CEBA, LEBA, and OEBA inputs.

54ACT16543...WD PACKAGE 74ACT16543 . . . DGG OR DL PACKAGE (TOP VIEW)



The 74ACT16543 is packaged in TI's shrink small-outline package, which provides twice the functionality of standard small-outline packages in the same printed-circuit-board area.

The 54ACT16543 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT16543 is characterized for operation from -40°C to 85°C.



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54ACT16543, 74ACT16543 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS126B - MARCH 1990 - REVISED APRIL 1996

FUNCTION TABLE (each octal register)

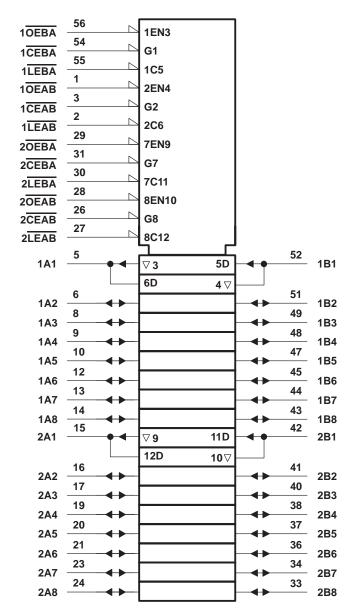
	INPUTS		LATCH STATUS	OUTPUT BUFFERS
CEAB	LEAB	OEAB	A TO BT	B1-B8
Н	Х	Х	Storing	Z
Х	Н	Χ	Storing	
Х	Χ	Н		Z
L	L	L	Transparent	Current A data
L	Н	L	Storing	Previous A data [‡]

[†] A-to-B data flow is shown: B-to-A flow control is the same except that it uses CEBA, LEBA, and OEBA.



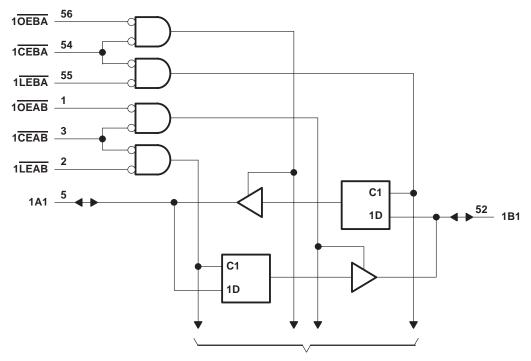
[‡] Data present before low-to-high transition of LEAB occurring while CEAB is low

logic symbol†

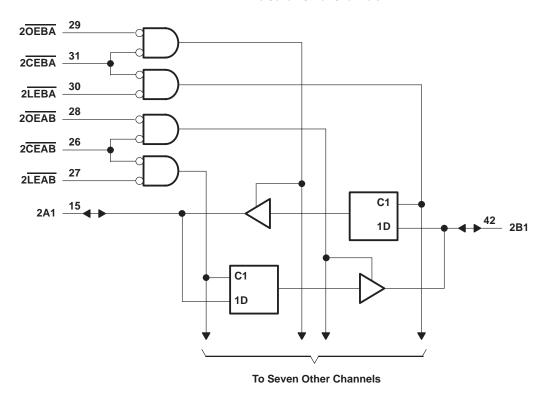


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



To Seven Other Channels





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	
Output voltage range, V _O (see Note 1)	
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND	±400 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2): DGG package 1 W
••	DL package
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		54	ACT165	43	74	ACT1654	13	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage (see Note 4)	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2		7	2			V
V _{IL}	Low-level input voltage		Ś	0.8			0.8	V
٧ _I	Input voltage	0	79.	VCC	0		VCC	V
Vo	Output voltage	0	1	VCC	0		VCC	V
ІОН	High-level output current		2	-24			-24	mA
loL	Low-level output current	20	5	24			24	mA
Δt/Δν	Input transition rise or fall rate	0		10	0		10	ns/V
TA	Operating free-air temperature	-55		125	-40		85	°C

NOTES: 3. Unused pins (inputs and I/O) must be held high or low to prevent them from floating.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

^{4.} All V_{CC} and GND pins must be connected to the proper voltage power supply.

54ACT16543, 74ACT16543 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCAS126B - MARCH 1990 - REVISED APRIL 1996

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DΛ	RAMETER	TEST CONDITIONS	Vaa	T,	Վ = 25°C	;	54ACT	16543	74ACT	16543	UNIT
FA	KAWETEK	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		Jour 50	4.5 V	4.4			4.4		4.4		
		IOH = -50 μA	5.5 V	5.4			5.4		5.4		
VOH		1011 - 24 mA	4.5 V	3.94			3.8		3.8		V
		I _{OH} = -24 mA	5.5 V	4.94			4.8		4.8		
		I _{OH} = -75 mA [†]	5.5 V				3.85	N.	3.85		
		15. 50.14	4.5 V		•	0.1		0.1		0.1	
		ΙΟΣ = 50 μΑ	5.5 V			0.1		0.1		0.1	
VOL		1a. 24 mA	4.5 V			0.36	Ó	0.44		0.44	V
		I _{OL} = 24 mA	5.5 V			0.36	20	0.44		0.44	
		I _{OL} = 75 mA [†]	5.5 V				² / ₂ O	1.65		1.65	
II	Control inputs	V _I = V _{CC} or GND	5.5 V			±0.1	7	±1		±1	μΑ
loz	A or B ports [‡]	V _O = V _{CC} or GND	5.5 V			±0.5		±5		±5	μΑ
ICC		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80		80	μΑ
Δlcc§		One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V			0.9		1		1	mA
Ci	Control inputs	V _I = V _{CC} or GND	5 V		4.5						nE.
Cio	A or B ports	$V_O = V_{CC}$ or GND	5 V		12						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		T _A = 2	25°C	54ACT	16543	74ACT	16543	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	ONIT
t _W	Pulse duration, LEAB or LEBA low	7.5		7.5	S'M	7.5		ns
t _{su}	Setup time, data before LEAB or LEBA↑	2.5		2.5	lle.	2.5		ns
t _h	Hold time, data after LEAB or LEBA↑	4		4		4		ns



For I/O ports, the parameter IOZ includes the input leakage current.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.

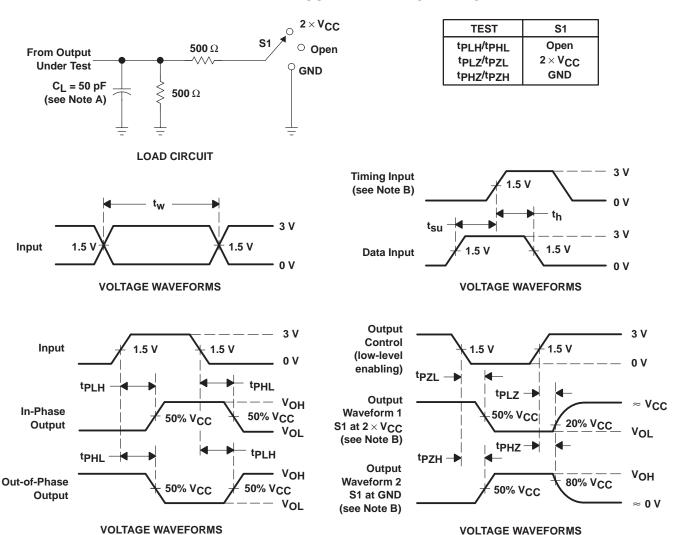
switching characteristics over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T,	λ = 25°C	;	54ACT	16543	74ACT	16543	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t PLH	A or B	B or A	3.5	6.9	9.5	3.5	10.5	3.5	10.5	ns
tPHL	AOIB	BOIA	3.1	7.3	10.7	3.1	11.6	3.1	11.6	115
^t PLH	LEBA or LEAB	A or B	3.9	8.6	12.3	3.9	13.8	3.9	13.8	ns
t _{PHL}	LEBA OF LEAB	AUIB	3.9	8.7	12.2	3.9	13.5	3.9	13.5	115
^t PZH	OEBA or OEAB	A or B	2.6	7.1	10.3	2.6	11.4	2.6	11.4	ns
tPZL	OEBA OF OEAB	AUIB	3.5	8.3	11.9	3.5	13.2	3.5	13.2	115
^t PHZ	OEBA or OEAB	A or B	4.1	8.2	10.5	43	11.1	4.1	11.1	ns
t _{PLZ}	OEBA OI OEAB	AOIB	5	7.3	9.3	0 5	9.6	5	9.6	115
^t PZH	CEBA or CEAB	A or B	3.1	7.3	10.7	3.1	11.7	3.1	11.7	ns
t _{PZL}	CEBA OF CEAB	AUIB	3.9	8.5	12.2	3.9	13.5	3.9	13.5	115
^t PHZ	CEBA or CEAB	A or B	4.6	8.5	11	4.6	11.6	4.6	11.6	ns
t _{PLZ}	CEDA OF CEAB	AB A or B	5.2	7.4	9.7	5.2	10.5	5.2	10.5	115

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER		TEST CO	NDITIONS	TYP	UNIT
<u> </u>	Dower discinction conscitance per transceiver	Outputs enabled	C ₁ = 50 pF,	f = 1 MHz	45	nE
Cpd	Power dissipation capacitance per transceiver	Outputs disabled	CL = 50 pr,	1 = 1 1/1/11/2	12	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f = 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGE OPTION ADDENDUM

10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
74ACT16543DGGR	ACTIVE	TSSOP	DGG	56	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT16543	Samples
74ACT16543DL	ACTIVE	SSOP	DL	56	20	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT16543	Samples
74ACT16543DLR	ACTIVE	SSOP	DL	56	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ACT16543	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

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PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2022

TAPE AND REEL INFORMATION





_		
	Α0	Dimension designed to accommodate the component width
П	B0	Dimension designed to accommodate the component length
	K0	Dimension designed to accommodate the component thickness
	W	Overall width of the carrier tape
Г	P1	Pitch between successive cavity centers

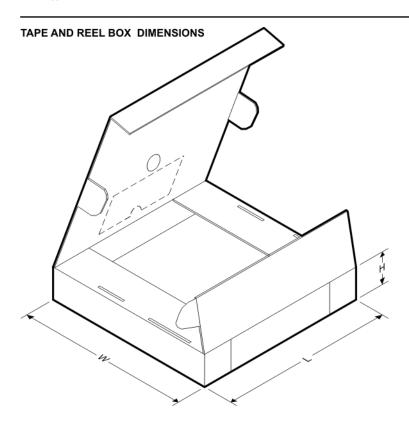
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
74ACT16543DGGR	TSSOP	DGG	56	2000	330.0	24.4	8.6	15.6	1.8	12.0	24.0	Q1
74ACT16543DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
74ACT16543DGGR	TSSOP	DGG	56	2000	367.0	367.0	45.0
74ACT16543DLR	SSOP	DL	56	1000	367.0	367.0	55.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
74ACT16543DL	DL	SSOP	56	20	473.7	14.24	5110	7.87

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